

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	"6879966".pn.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/19 11:45
L2	1	"6879966".pn.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/19 12:31
L3	0	2001-172267	JPO	OR	ON	2005/04/19 12:31
L4	1	"2001172267"	JPO	OR	ON	2005/04/19 12:31
S1	1943	(card or carrier) with chlorine	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 12:43
S2	147	(card or carrier) with chlorine with (sheet or core or layer)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 12:44
S3	2	(card or carrier) with chlorine with (sheet or core or layer) and card.ti.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 12:45
S4	6	(card or carrier) with chlorine and card.ti.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 12:47
S5	1	"4879153".pn.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 12:48
S6	350	card.ti. and (sheet or core or layer or film) with (terephthalic or cyclohexanedimethanol or glycol or polycarbonate)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:18
S7	116	card.ti. and (sheet or core or layer or film) with (terephthalic or cyclohexanedimethanol or glycol or polycarbonate) and (hole or recess or cavity)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:04
S8	5	card.ti. and (sheet or layer or film) near5 core with (terephthalic or cyclohexanedimethanol or glycol or polycarbonate) and (hole or recess or cavity)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:04
S9	49	card.ti. and (core near5 sheet) same (hole or recess or cavity) same (chip or ic or processor)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:09
S10	1	"6719206".pn.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:13
S11	196	card.ti. and chip same (antenna or coil) same (cavity or recess or hole)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:19

S12	92	card same (chip or ic or processor) same (antenna or coil) same insulat\$4 with substrate	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:28
S13	1	"6440773".pn.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:31
S15	10	card with (recess or cavity) with (chip or module or processor or microprocessor) same plate with (reinforc\$4 or protect\$4)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:32
S16	321	card same (recess or cavity or hole) same (chip or module or processor or microprocessor) same (antenna or coil)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:33
S17	34	card same (recess or cavity or hole) same (chip or module or processor or microprocessor) same (antenna or coil) same insulat\$4	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:33
S18	96	235/492.ccls. and (contactless or "non contact") and (recess or cavity) same (chip or IC or processor or module)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:36
S19	44	235/492.ccls. and (contactless or "non contact") and (recess or cavity) same (chip or IC or processor or module) same (antenna or coil)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:42
S20	5	card same "chip reinforcing plate"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:44
S21	108	card same "reinforcing plate"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:44
S22	83	card with "reinforcing plate"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:50
S23	25	card same (hole or cavity or recess) same "reinforcing plate"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 13:50
S24	1	card same multilayer near5 (sheet or core) same (antenna or coil) same (chip or ic or module or processor)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 14:06
S25	46	card same multilayer near5 (sheet or core)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 14:06

S26	49	(US-5434618-\$ or US-5168151-\$ or US-5105074-\$ or US-4814591-\$ or US-6352604-\$ or US-6180434-\$ or US-5809633-\$ or US-5304513-\$ or US-6764014-\$ or US-6709889-\$ or US-6677186-\$ or US-6607135-\$ or US-6440773-\$ or US-6412701-\$ or US-5969951-\$ or US-4879153-\$ or US-6283378-\$ or US-5346576-\$ or US-5026452-\$ or US-6719206-\$ or US-5013900-\$ or US-4843225-\$ or US-5701002-\$ or US-5852289-\$ or US-6352767-\$ or US-5888624-\$).did. or (US-20040193774-\$ or US-20040177215-\$ or US-20040056083-\$ or US-20020170974-\$ or US-20040169086-\$ or US-20040026518-\$ or US-20030178495-\$ or US-20030169574-\$ or US-20040161690-\$ or US-20040126690-\$ or US-20040171192-\$ or US-20030038174-\$ or US-20030214794-\$ or US-20030226901-\$ or US-20030057536-\$ or US-20040112967-\$ or US-20010015382-\$ or US-20040129788-\$ or US-20010040186-\$).did. or (JP-09050503-\$ or JP-2003242475-\$ or JP-2003034009-\$ or JP-2002163624-\$).did.	US-PGPUB; USPAT; JPO	OR	OFF	2004/10/11 15:10
S27	8	S26 and multilayer	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/11 15:10
S28	840	(card or carrier or tag or id or RFID or identification) with clock with (speed or frequency) near5 (chang\$4 or adjust\$4 or increas\$4 or decreas\$4 or alter\$4 or modif\$9 or speed\$4 or slow\$4 or rais\$4 or lower\$4)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 12:21

S29	23	(card or carrier or tag or id or RFID or identification) with clock with (speed or frequency) near5 (chang\$4 or adjust\$4 or increas\$4 or decreas\$4 or alter\$4 or modif\$9 or speed\$4 or slow\$4 or rais\$4 or lower\$4) same (display\$4 or screen or lcd or "liquid crystal")	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 13:02
S30	2	("5684672" "5598174").pn.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 14:07
S31	139079	"427"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 14:08
S32	84838	"427"/\$.ccls.	USPAT	OR	ON	2004/10/07 14:10
S33	501	card with display\$4 with clock	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 14:11
S34	29	card with display\$4 with clock near5 (frequency or speed)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 17:28
S35	1	card near5 (smart or ic or chip or "integrated circuit") same (total\$4 or sum\$4 or combin\$4) with height with (hole)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 17:30
S36	0	"20040159709".URPN.	USPAT	OR	ON	2004/10/07 17:30
S37	24	card near5 (smart or ic or chip or "integrated circuit") same (total\$4 or sum\$4 or combin\$4) with height	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 17:31
S38	117	card near5 (smart or ic or chip or "integrated circuit") same (total\$4 or sum\$4 or combin\$4) with thick\$4	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 17:39
S39	38	card near5 (smart or ic or chip or "integrated circuit") same (total\$4 or sum\$4 or combin\$4) with thick\$4 with (layer or film or core or sheet)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 17:46
S40	226	card near5 (smart or ic or chip or "integrated circuit") with ("through hole")	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 17:56
S41	227	("235"/\$.ccls.) and (card near5 (smart or ic or chip or "integrated circuit" or processor) with ("through hole" or cavity or hole) with (chip or ic or circuit or processor))	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 18:15

S42	14	("235"/\$.ccls.) and (card near5 (smart or ic or chip or "integrated circuit" or processor) with ("through hole" or cavity or hole) with (chip or ic or circuit or processor) same reinforc\$4)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 18:18
S43	3	("235"/\$.ccls.) and (card near5 (smart or ic or chip or "integrated circuit" or processor) with ("through hole" or cavity or hole) with (chip or ic or circuit or processor) with flush)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 18:19
S44	46	(card near5 (smart or ic or chip or "integrated circuit" or processor) with ("through hole" or cavity or hole) with (chip or ic or circuit or processor) with (flat or flush))	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 18:24
S45	17	card with (micron or micrometer or um) same (smart or ic or chip or processor or circuit) same (cavity or hole or recess)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 18:28
S46	50	card same (antenna or coil) same (reinforc\$4 or protect\$4) same (cavity or hole or recess) same (chip or ic or circuit or processor)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/07 18:38
S47	168	card near5 (chip or ic or circuit or processor or smart) same (antenna or coil) same (core or layer or film) same (cavity or hole or recess)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 11:59
S48	80	"235"/\$.ccls. and card same (chip or ic or processor or circuit) same insulat\$4 same (antenna or coil)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 12:00
S49	16	"235"/\$.ccls. and card same (chip or ic or processor or circuit) same insulat\$4 same (antenna or coil) same (reinforc\$4 or plate)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 12:04
S50	2	card same (chip or ic or processor or circuit) same insulat\$4 same (antenna or coil) same core same (cavity or hole or recess)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 12:05
S51	21	card same (chip or ic or processor or circuit) same insulat\$4 same (antenna or coil) same core	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 12:08
S52	363	card same (chip or ic or processor or circuit) same insulat\$4 same (antenna or coil)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 12:14
S53	3	card near5 (chip or ic or processor or circuit or smart) same resin same (cavity or hole or recess) same insulat\$4 same (core)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 12:16



S54	4814	card near5 (chip or ic or processor or circuit or smart) same (cavity or hole or recess)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 12:16
S55	98	card near5 (chip or ic or processor or circuit or smart) same (cavity or hole or recess) and (reinforc\$4 or protect\$4) near3 plate	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 13:58
S56	39	235/492.ccls. and layer same core same (resin or binder or adhesive or filler or glue)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:04
S57	24	"235"/\$.ccls. and card same (sheet or layer) same core same (resin or binder or adhesive or filler or glue) and (contactless or "non contact" or wireless)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:05
S58	836	card same (layer or sheet or film or core) same (terephthalic or cyclohexanedimethanol or glycol or polycarbonate)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:09
S59	80	card near5 (smart or chip or ic or circuit or processor) same (layer or sheet or film or core) same (terephthalic or cyclohexanedimethanol or glycol or polycarbonate)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:10
S60	3	card near5 (smart or chip or ic or circuit or processor) same (layer or sheet or film or core) same (chlorine)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:11
S61	11	card near5 (smart or chip or ic or circuit or processor) same (chlorine)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:12
S62	57	card same (chlorine)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:21
S63	105	card same plate same chip same (reinforc\$6 or protect)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:22
S64	69	card same plate with chip with (reinforc\$6 or protect)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:28
S65	9	card same plate with chip with (reinforc\$6 or protect) same (hole or cavity or recess)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:31
S66	5	card same plate same chip same (reinforc\$6 or protect) same (hole or cavity or recess) same (filler or adhesive or resin) same (layer or sheet or core of film)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:40

S67	3	card with (coil or antenna) same plate with (protect\$4 or reinforc\$4) same (core or layer or sheet or film or substrate) same (recess or cavity or hole) same (chip or processor or module or smart or ic or circuit)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:41
S68	7787	card same (cavity or "through hole" or hole or recess) same (smart or ic or chip or processor or circuit)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:52
S69	61	card same (cavity or "through hole" or hole or recess) same (smart or ic or chip or processor or circuit) same plate with (protect\$4 or reinforc\$4)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 14:55
S70	139	card same (cavity or "through hole" or hole or recess) same fill\$4 with (filler or adhesive or glue or resin) same (layer or film or core or substrate)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:06
S71	216	card same plate with (reinforc\$4)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:06
S72	22	card same plate with (reinforc\$4) same (antenna or coil) same (chip or smart or ic or module or processor or circuit)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:09
S73	26	card same plate with (reinforc\$4) same (antenna or coil)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:09
S74	152	card near4 (smart or ic or chip or processor or circuit) same core with sheet	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:16
S75	48	card near4 (smart or ic or chip or processor or circuit) same core with sheet same (recess or cavity or hole)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:25
S76	16	(card near4 (smart or ic or chip or processor or circuit) same core with sheet same (recess or cavity or hole)) and (coil or antenna)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:26
S77	59	(card) near5 (smart or chip or IC or processor) same (coil or antenna) same core with (film or layer or sheet)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:58
S78	901	(card) near5 (smart or chip or IC or processor) same (coil or antenna) with (core or film or layer or sheet or substrate)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:59

S79	687	(card) near5 (smart or chip or IC or processor) with (coil or antenna) with (core or film or layer or sheet or substrate)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:59
S80	98	(card) near5 (smart or chip or IC or processor) with (coil or antenna) with (core or film or layer or sheet or substrate) with insulat\$4	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 15:59
S81	1	"5809663".pn.	USPAT	OR	ON	2004/10/08 16:11
S82	1	"5809633".pn.	USPAT	OR	ON	2004/10/08 16:12
S83	21	card with (antenna or coil) with (chip or ic) with (substrate or core) same (cavity or hole or recess)	USPAT	OR	ON	2004/10/08 16:18
S84	27	235/492.ccls. and card same (cavity or recess) same (antenna or coil) same (core or layer or substrate)	USPAT	OR	ON	2004/10/08 16:19
S85	42	"235"/\$.ccls. and card with (chip or ic or processor) with (cavity or recess or hole) with (antenna or coil)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/10/08 16:32
S86	1	"6719206".pn.	USPAT	OR	ON	2004/10/08 16:48
S87	264	card same (cavity or hole or recess or cutout or cut) near5 (height or tall or size) same (ic or chip or processor or circuit)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 14:07
S88	152	card same (cavity or hole or recess or cutout or cut) near5 (height or tall or size or deep) with (ic or chip or processor or circuit)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 14:08
S89	299	card same (cavity or hole or recess or cutout or cut) near5 (height or tall or size or deep) same (ic or chip or processor or circuit)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 14:09
S90	0	("2004/0159709").URPN.	USPAT	OR	ON	2005/04/18 14:08
S91	7	card same (cavity or hole or recess or cutout or cut) near5 (height or tall or size or deep) with (".mu.m\$" or "mu" or micrometer or micro\$3 or "mum" or "mu.m\$") same (ic or chip or processor or circuit)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 14:17
S92	33	card same (cavity or hole or recess or cutout or cut) near5 (height or tall or size or deep) with (".mu.m\$" or "mu" or micrometer or micro\$3 or "mum" or "mu.m\$")	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 14:17



S93	50	(US-20010015382-\$ or US-20010040186-\$ or US-20020170974-\$ or US-20030038174-\$ or US-20030057536-\$ or US-20030169574-\$ or US-20030178495-\$ or US-20030214794-\$ or US-20030226901-\$ or US-20040026518-\$ or US-20040056083-\$ or US-20040112967-\$ or US-20040126690-\$ or US-20040129788-\$ or US-20040161690-\$ or US-20040169086-\$ or US-20040171192-\$ or US-20040177215-\$ or US-20040193774-\$ or US-20030029921-\$).did. or (US-4814591-\$ or US-4843225-\$ or US-4879153-\$ or US-5013900-\$ or US-5026452-\$ or US-5105074-\$ or US-5168151-\$ or US-5304513-\$ or US-5346576-\$ or US-5434618-\$ or US-5701002-\$ or US-5809633-\$ or US-5852289-\$ or US-5888624-\$ or US-5969951-\$ or US-6180434-\$ or US-6283378-\$ or US-6352604-\$ or US-6352767-\$ or US-6412701-\$ or US-6440773-\$ or US-6607135-\$ or US-6677186-\$ or US-6709889-\$ or US-6719206-\$ or US-6764014-\$).did. or (JP-09050503-\$ or JP-2002163624-\$ or JP-2003034009-\$ or JP-2003242475-\$).did.	US-PGPUB; USPAT; JPO	OR	ON	2005/04/18 15:24
S94	33	S93 and (cavity or hole or recess)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:29
S95	2073	card with ("through hole" or "through-hole")	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:30
S96	918	card with ("through hole" or "through-hole") same (IC or chip or circuit or processor)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:31
S97	19	card with ("through hole" or "through-hole") near3 (height or size or tall)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:31
S98	7	card same "reinforcing plate" same ("through hole" or "through-hole")	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:40

S99	2925	card same (cavity or recess or hole) same (press\$4)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:41
S10 0	918	card same (cavity or recess or hole) same (press\$4) same (chip or circuit or ic)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:55
S10 1	8	card same (cavity or recess or hole) same (press\$4) same (chip or circuit or ic) same ("reinforcing plate")	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:57
S10 2	20	card same (cavity or recess or hole) same (press\$4) same (chip or circuit or ic) same ("reinforcing plate" or reinforc\$4)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 15:57
S10 3	133	card same (cavity or recess or hole) same (chip or circuit or ic) same ("reinforcing plate" or reinforc\$4)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 16:03
S10 4	10	card same (cavity or recess or hole) same (chip or circuit or ic) same ("reinforcing plate" or reinforc\$4) same (antenna or coil)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 16:03

S10 5	53	(US-20010015382-\$ or US-20010040186-\$ or US-20020170974-\$ or US-20030038174-\$ or US-20030057536-\$ or US-20030169574-\$ or US-20030178495-\$ or US-20030214794-\$ or US-20030226901-\$ or US-20040026518-\$ or US-20040056083-\$ or US-20040112967-\$ or US-20040126690-\$ or US-20040129788-\$ or US-20040161690-\$ or US-20040169086-\$ or US-20040171192-\$ or US-20040177215-\$ or US-20040193774-\$ or US-20030029921-\$ or US-20030085454-\$).did. or (US-4814591-\$ or US-4843225-\$ or US-4879153-\$ or US-5013900-\$ or US-5026452-\$ or US-5105074-\$ or US-5168151-\$ or US-5304513-\$ or US-5346576-\$ or US-5434618-\$ or US-5701002-\$ or US-5809633-\$ or US-5852289-\$ or US-5888624-\$ or US-5969951-\$ or US-6180434-\$ or US-6283378-\$ or US-6352604-\$ or US-6352767-\$ or US-6412701-\$ or US-6440773-\$ or US-6607135-\$ or US-6677186-\$ or US-6709889-\$ or US-6719206-\$ or US-6764014-\$).did. or (US-5250341-\$).did. or (JP-09050503-\$ or JP-2002163624-\$ or JP-2003034009-\$ or JP-2003242475-\$ or JP-2004185208-\$).did.	US-PGPUB; USPAT; JPO	OR	ON	2005/04/18 16:09
S10 6	53	S105	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 16:10
S10 7	9	S105 and laminate with layer	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 16:11
S10 8	133	card same reinforc\$4 same (cavity or recess or hole or "through-hole") same (chip or ic or circuit)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/04/18 16:13